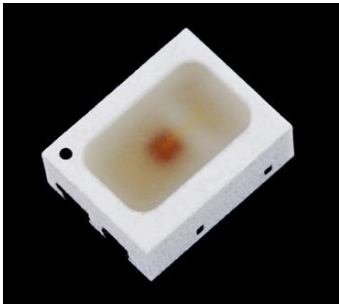


Standard Product Reference Sheet

VFSR1112GS-3CX2A-TR



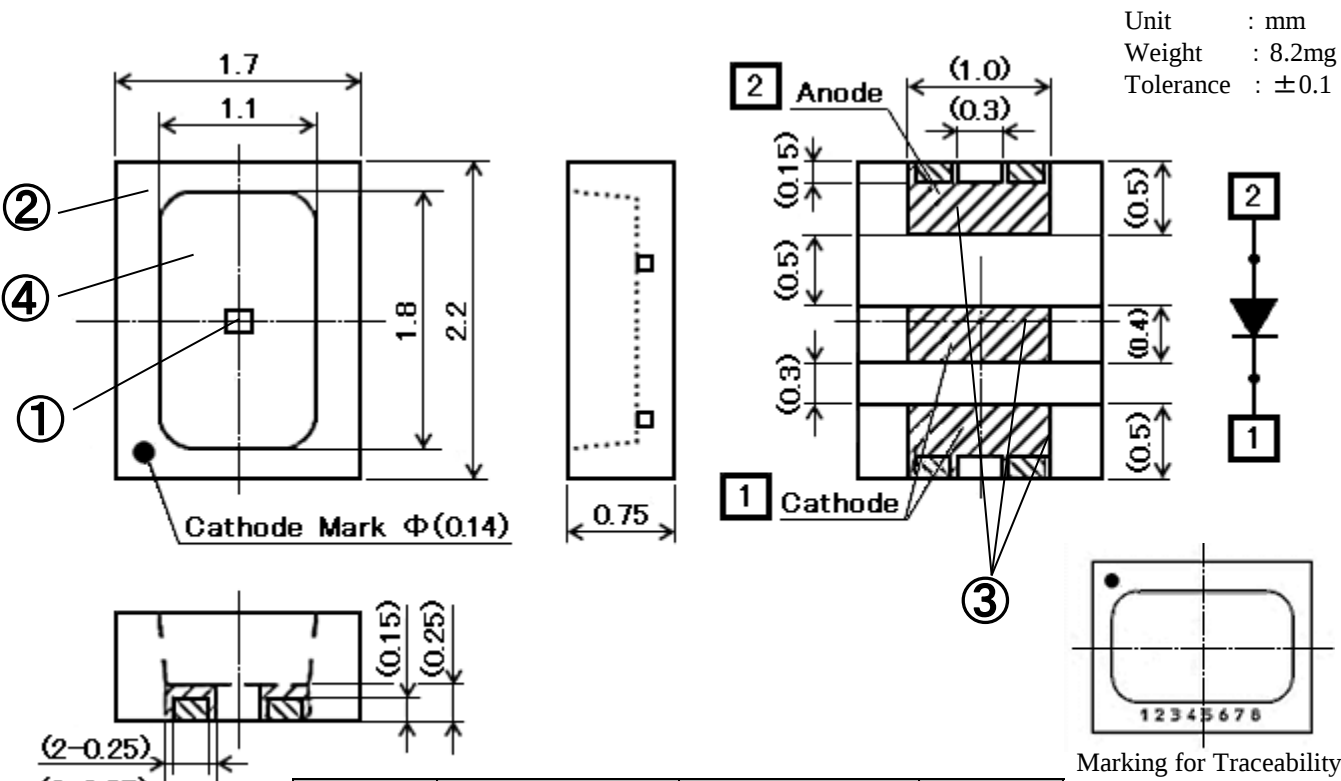
Package	SMD Top view Package, Red color emitting LED Outer dimension 2.2 x 1.7 x 0.75mm (L x W x H)
Product features	• Small-sized, high-brightness package • Moisture sensitive level : 2a • Lead-free soldering compatible • RoHS compliant

Recommended Applications

- Light source for Automotive use, Back light, Various indicator, etc.

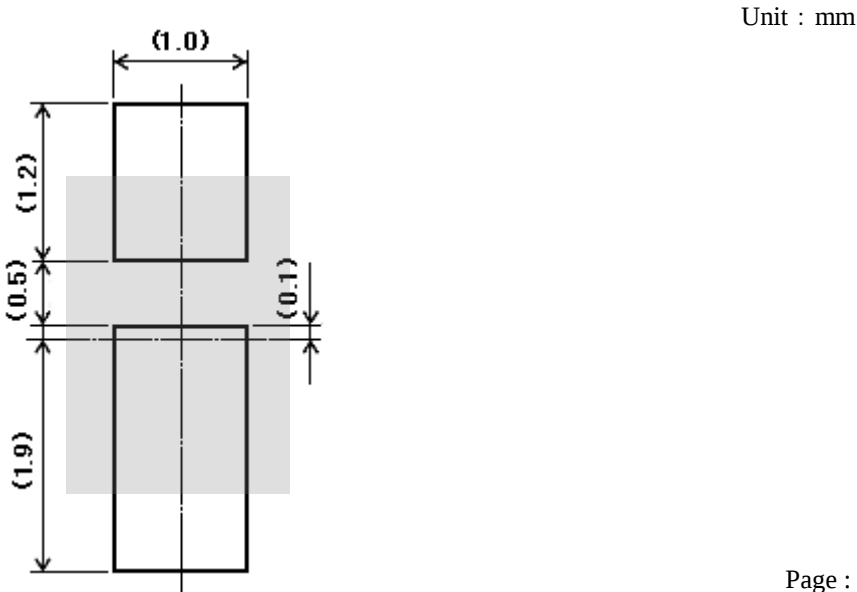
Outline Dimensions

VFSR1112GS-3CX2A-TR



No	Part Name	Material	QTY.
①	LED Die	AlGaInP	1
②	Lamp housing	White Resin	1
③	Electrode	Pd/Au Plating	Cathode:2 Anode:1
④	Encapsulant	Silicone Resin	1

Recommended Soldering Pattern



Specifications

VFSR1112GS-3CX2A-TR

【 Product Overview 】

Die Material	AlGaInP
Emitting Color	Red
Resin Color 【Emitting Area】	Pale Milky White
Lamp Housing Color	White

【 Absolute Maximum Ratings 】

(Ta=25°C)			
ITEM	SYMBOL	MAXIMUM RATINGS	UNITS
Power Dissipation	P_d	196	mW
Forward Current	I_F	70	mA
Repetitive Peak Forward Current 【1ms, 1/10Duty】	I_{FRM}	100	mA
I_F Derate Linearly 【Ta=from 85°C】	ΔI_F	2.8	mA
I_{FRM} Derate Linearly 【Ta=from 85°C】	ΔI_{FRM}	4.0	mA
Reverse Current	V_R	5	V
Operarting Temperature	T_{opr}	-40 ~ +100	°C
Storage Temperature	T_{stg}	-40 ~ +110	°C
Junction Temperature	T_j	110	°C
Electrostatic Discharge Threshold 【HBM】	ESD	2,000	V
Soldering Temperature 【Reflow Soldering】	T_{sld}	260	°C

Note1 ESD testing method : EIAJ4701/300(304) Human Body Model(HBM) 1.5kΩ,100pF

Note2 Please refer to page 8, Soldering Conditions.

【 Thermal Characteristics 】

(Ta=25°C)			
ITEM	SYMBOL	TYP.	UNITS
Thermal Resistance 【Junction - Ambient】	$R_{th(j-s)}$	150	°C/W
Thermal Resistance 【Junction - Solder Point】	$R_{th(j-s)}$	80	°C/W

Note3 Rth(j-a) Measurement Condition

- Substrate:FR4 (t=1.6mm)
- Pattern Size : 16mm²

Specifications

VFSR1112GS-3CX2A-TR

【 Electro-Optical Characteristics 】

(Ta=25°C)						
ITEM	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Forward Voltage	V_F	$I_F = 20\text{mA}$	1.7	2.0	2.8	V
Reverse Current	I_R	$V_R = 5\text{V}$	-	-	5.0	μA
Luminous Intensity	I_V	$I_F = 20\text{mA}$	560	700	1,000	mcd
Luminous Flux	Φ_V	$I_F = 20\text{mA}$	-	2.05	-	lm
Peak Wavelength	λ_p	$I_F = 20\text{mA}$	-	635	-	nm
Dominant Wavelength	λ_d	$I_F = 20\text{mA}$	620	624	632	nm
Spectral Line Half Width	$\Delta\lambda$	$I_F = 20\text{mA}$	-	17	-	nm
Half Intensity Angle	$\Delta\theta_x$	$I_F = 20\text{mA}$	-	115	-	deg.
	$\Delta\theta_y$		-	115	-	

Note4 Tolerance:±0.1V

Note5,6 Please refer to the attached sheets, each sorting chart.

Note7 Viewing Angle at 50% I_V , $\Delta\theta_X$; Housing long side axis, $\Delta\theta_Y$; Housing short side axis

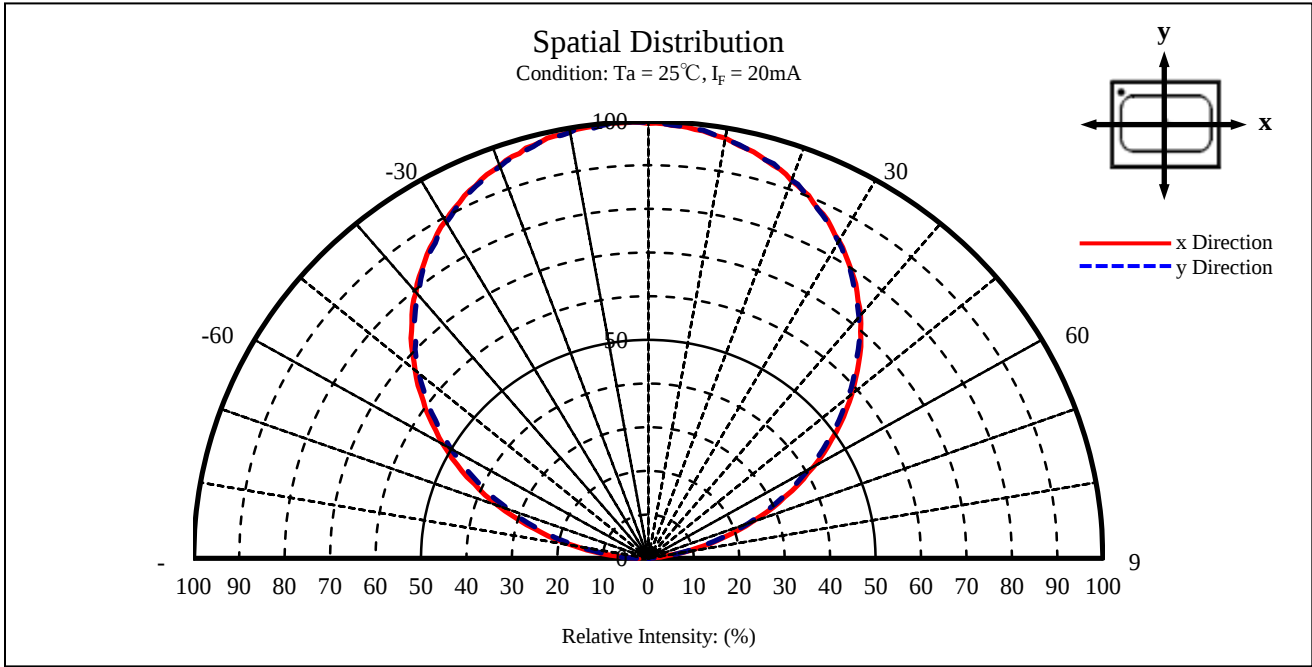
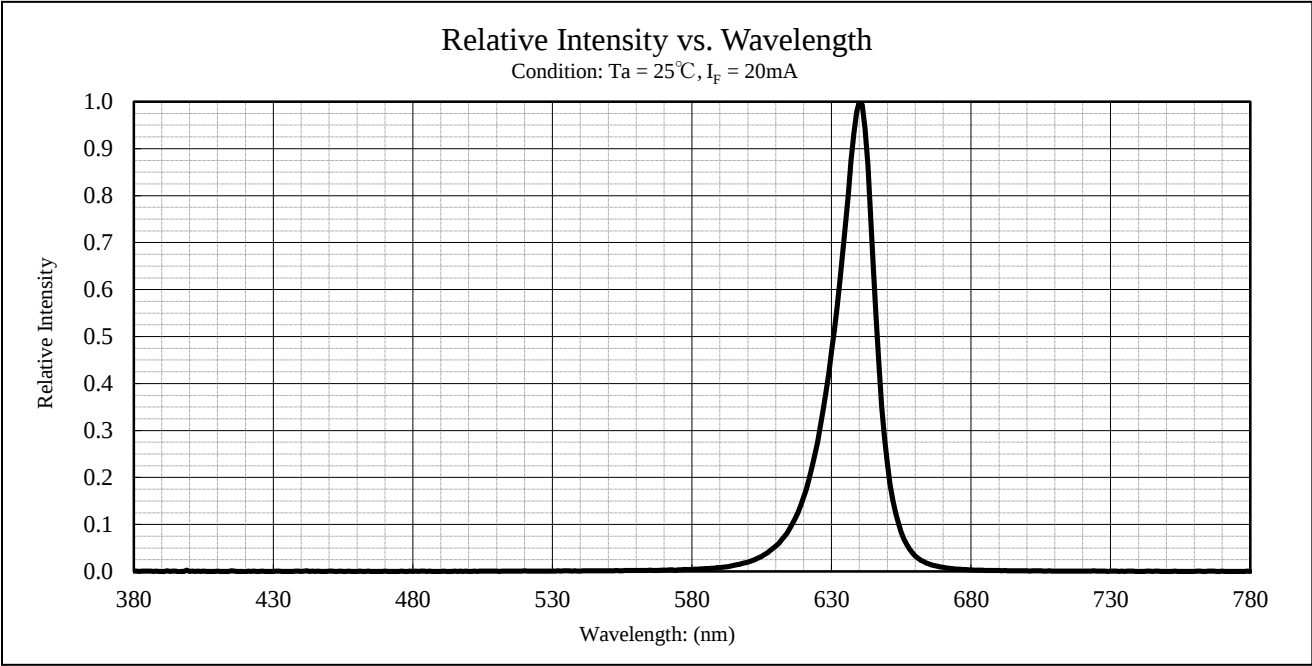
【 Sorting Chart for Luminous Intensity, I_V 】

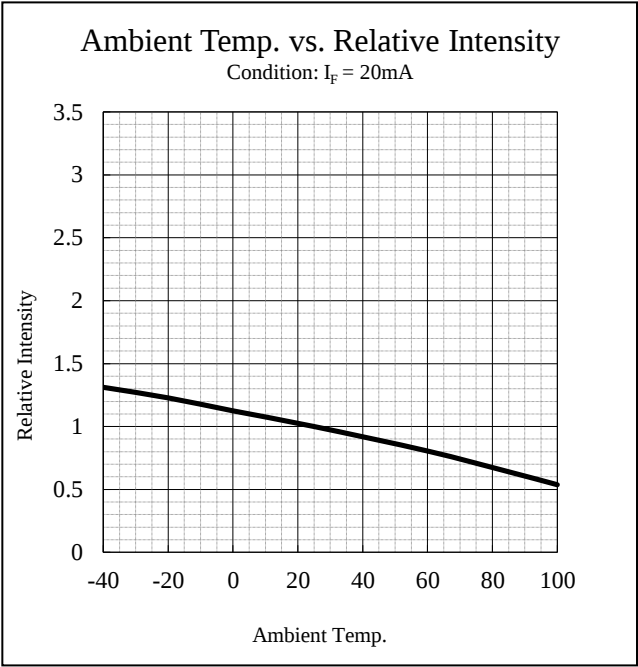
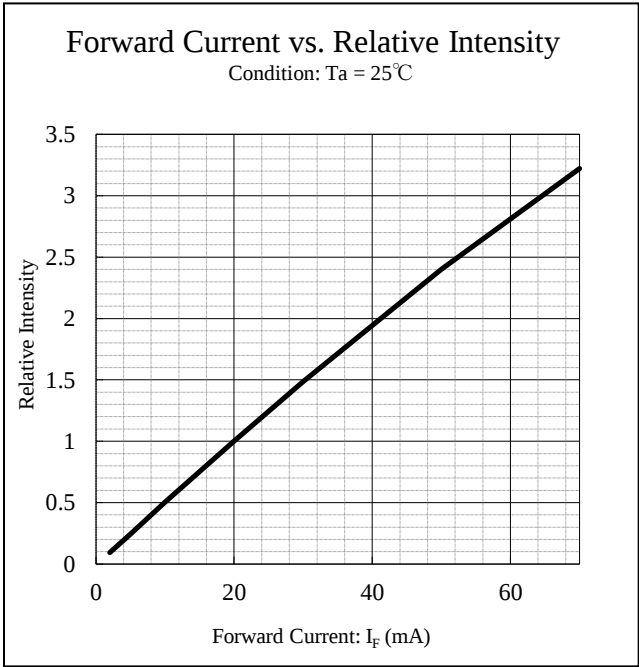
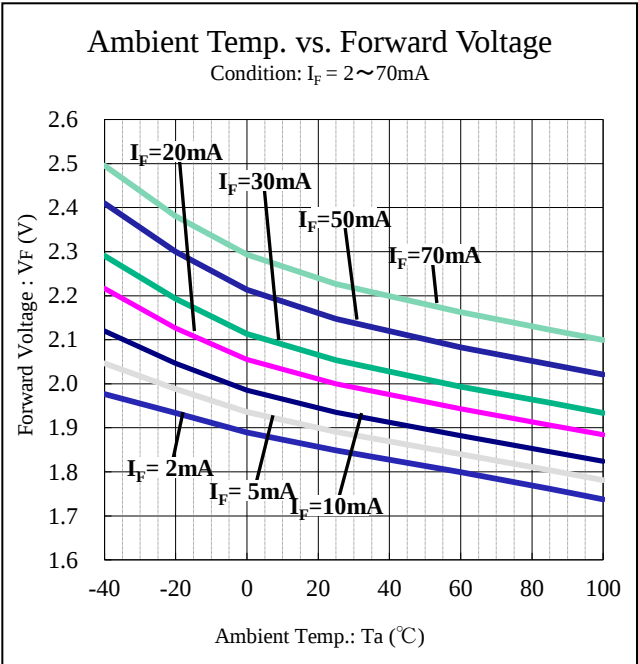
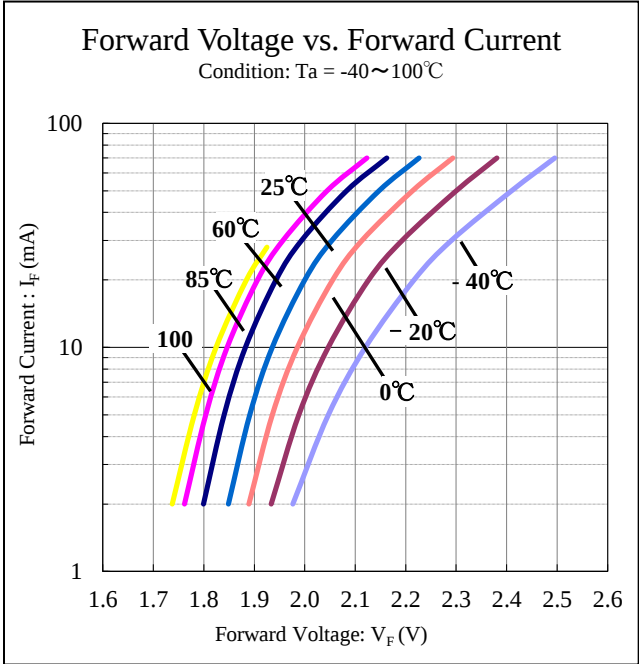
LEDs shall be sorted out into the following chart and each rank parts shall be packed separately when shipping.

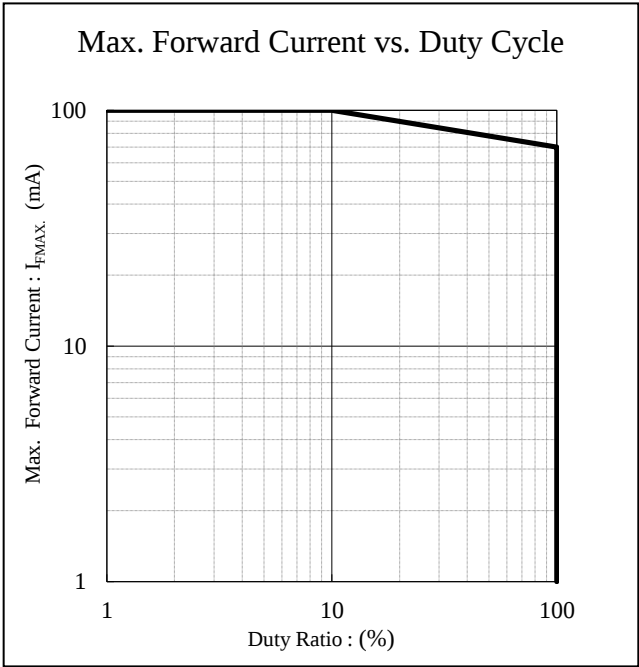
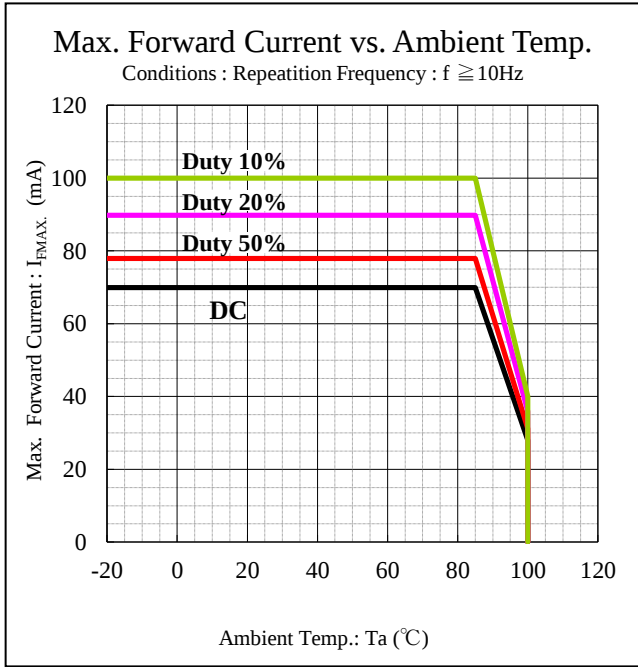
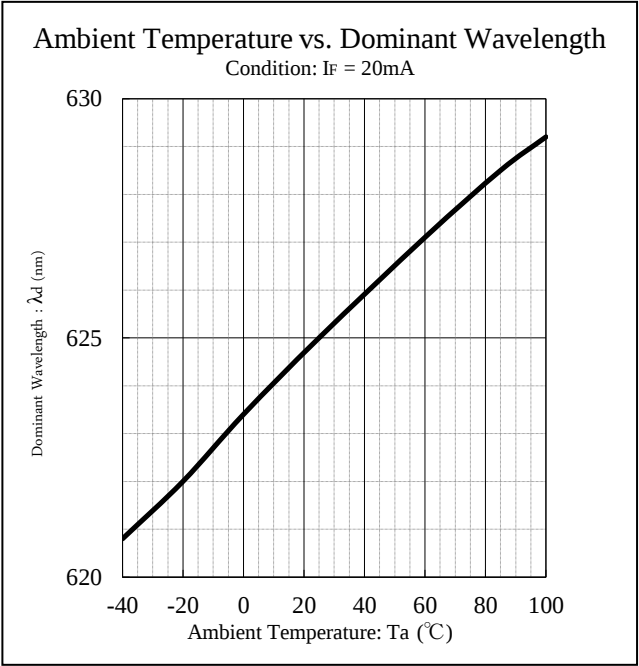
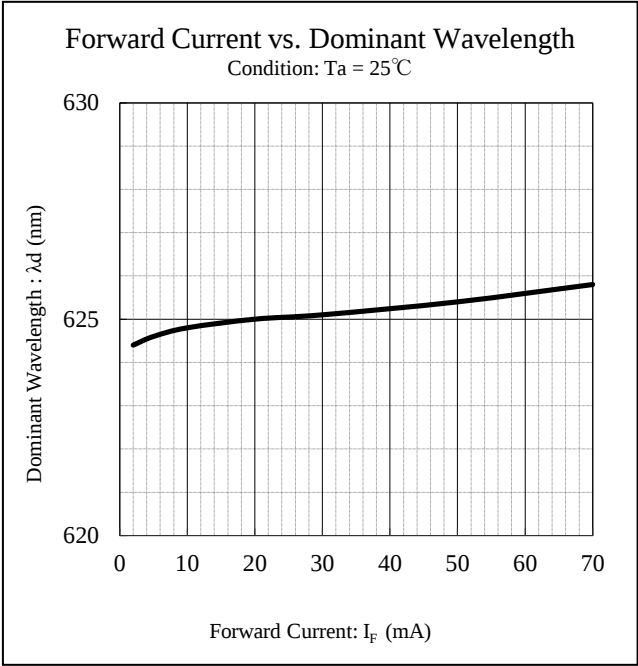
Luminous Intensity (I_V) Rank				Dominant Wavelength (λ_d) Rank			
Rank	I_V (mcd)		Conditions	Rank	λ_d (nm)		Conditions
	MIN.	MAX.			MIN.	MAX.	
CX	560	680	$I_F = 20\text{mA}$ $T_a = 25^\circ\text{C}$	A	620	626	$I_F = 20\text{mA}$ $T_a = 25^\circ\text{C}$
CY	680	820		B	626	632	
CZ	820	1,000					

Above the table of Luminous Intensity (I_V) values and Dominant Wavelength (λ_d) values are the setup of the selection machine.

【Tolerance I_V : ±10%, λ_d : ±1nm】







Soldering condition

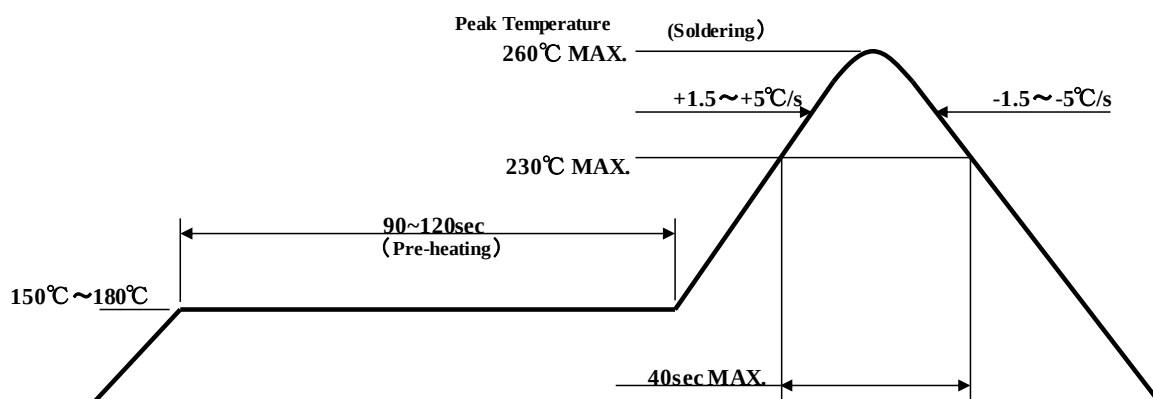
VFSR1112GS-3CX2A-TR

【Soldering Precaution】

(acc.to EIAJ-4701/300)

- Heat stress during soldering will influence the reliability of LEDs, however that effect will vary on heating method. Also, if components of varying shape are soldered together, it is recommended to set the soldering pad temperature according to the component most vulnerable to heat (e.g., surface mount LED).
- LED parts including the resin are not stable immediately after soldering (when they are not at room temperature), any mechanical stress may cause damage to the product. Please avoid such stress after soldering, especially stacking of the boards which may cause the boards to warp and any other types of friction with hard materials.
- Recommended temperature profile for the Reflow soldering is listed as the temperature of the resin surface. Temperature distribution varies on heating method, PCB material, other components in the assembly, and mounting density .
Please do not repeat the heating process in Reflow process more than twice.

【Recommended Reflow Soldering Condition 】



Note 1 Temperature Profile for the reflow should be set to the surface temperature of resin which is on the top of LED. This should be the maximum temperature for soldering. Lowering the heating temperature and decreasing heating time is very effective in achieving higher reliability.

Note 2 The reflow soldering process should be done up to twice(2 times Max). When second process is performed, interval between first and second process should be as short as possible to prevent absorption of moisture to resin of LED. The second soldering process should not be done until LEDs have returned to room temperature (by nature-cooling) after first soldering process.

Soldering condition

VFSR1112GS-3CX2A-TR

4. If soldering manually, Stanley recommends using a soldering iron equipped with temperature control. During the actual soldering process, make sure that the soldering iron never touches the LED itself, and avoid the LED's electrode heating temperature reaching above the heating temperature of the solder pad. All repairs must be performed only once in the same spot, and please avoid reusing components.
5. In soldering process, immediately after iron tip is cleaned, please make sure that the soldering iron reaches the appropriate temperature before using. Also, please avoid applying any types of pressure to the soldered components before the solder has been cooled and hardened, as it may deteriorate solder performance and solder quality.

【Recommended Manual Soldering Condition】

Temperature of Iron Tip	350℃MAX.
Soldering Duration, Time	3sec.Max.,1 time

6. When using adhesive material for tentative fixatives, thermosetting resin or Ultraviolet radiation (UV) setting resin with heat shall be recommended.
《The curing condition, Temperature:150℃Max./Time:300sec.Max.》
7. Flow soldering (dip soldering) is not recommended for this product.
8. Isopropyl alcohol is recommended for cleaning. Some chemicals, including Freon substitute detergent could corrode the lens or the casing surface, which cause discoloration, cloud, crack and so on. Please review the reference chart below for cleaning. If water is used to clean (including the final cleaning process), please use pure water (not tap water), and completely dry the component. Cleaning with ultrasonic is not recommended.

Chemical	Adaptability
Isopropyl Alcohol	✓
Trichloroethylene	×
Chlorothen	×
Acetone	×
Thinner	×

【For Electric Static Discharge (ESD)】

This type of LED lamp is highly sensitive to surge voltage generated by the On/Off status change and discharges of static electricity through frictions with synthetic materials, which may cause severe damage to the die or undermine its reliability. Damaged products may experience conditions such as extremely high reverse voltage, or a decrease of forward rise voltage, deteriorating its optical characteristic.

Stanley products are designed to withstand up to 1,000V under the EIAJ ED-4701/300 Test #304 (HBM), and are packed with anti-static components. However, the following precautions and measures are vital in ensuring product quality during shipment.

EIAJ ED-4701/300(304/HBM) Electrification model: $C=100\text{pF}$, $R_2=1.5\text{K}\Omega$

1. Electrification/Static Electricity protection

Stanley recommends the following precautions in order to avoid product (die) damage from static electricity , when an operator and other materials electrified by friction coming in contact with the product.

- ① Do not place electrified non-conductive materials near the LED product.
Avoid LED products from coming into contact with metallic materials.(Should the metallic material be electrified , the sudden surge voltage will most likely damage the product.)
- ② Avoid a working process which may cause the LED product to rub against other materials.
- ③ Install ground wires for any equipment, where they can be installed, with measures to avoid static electricity surges.
- ④ Prepare a ESD protective area by placing a Conductive Mattress (1M Ω MAX.) and Ionizer to remove any static electricity.
- ⑤ Operators should wear a protective wrist-strap.
- ⑥ Operators should wear conductive work-clothes and shoes.
- ⑦ To handle the products directly, Stanley recommends the use of ceramic, and not metallic, tweezers.

2. Working Environment

- ① A dry environment is more likely to cause static electricity. Although a dry environment is ideal for storage state of LED products, Stanley recommends an environment with approximately 50% humidity after the soldering process.
- ② Recommended static electricity level in the working environment is less than 150V, which is the same value as Integrated Circuits (which are sensitive to static electricity).

【Other Precautions】

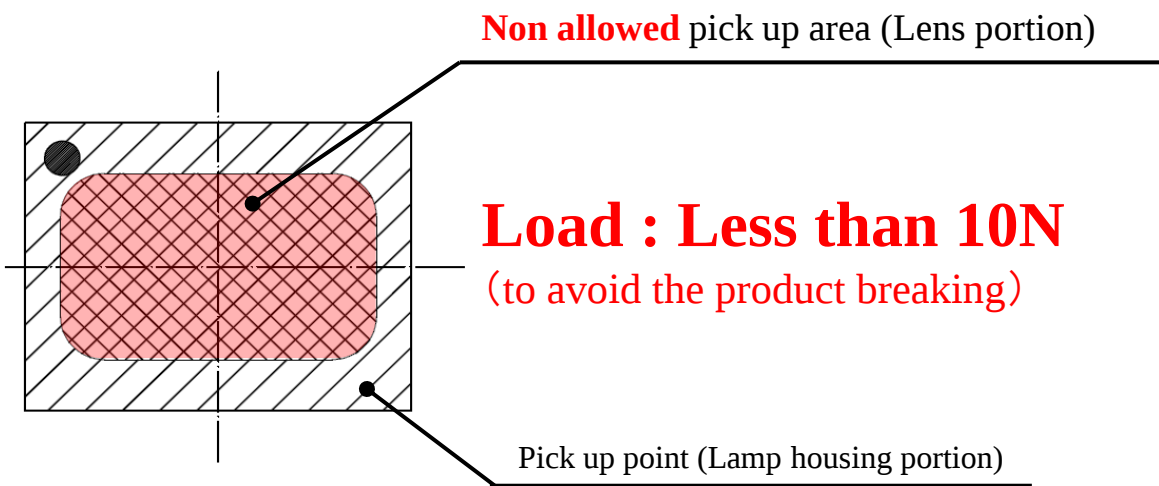
1. Stanley LED Lamps have semiconductor characteristics and are designed to ensure high reliability. However, the performance may vary depending on usage conditions.
2. Absolute Maximum Ratings are set to prevent LED lamps from failing due to excess stress(temperature, current, voltage, etc.). Usage conditions must not exceed the ratings for a moment, nor do reach one item of absolute maximum ratings simultaneously.
3. In order to ensure high reliability from LED Lamps, variable factors that arise in actual usage conditions should be taken it to account for designing. (Derating of TYP., MAX Forward Voltage, etc.)
4. Please insert Straight Protective Resistors into the circuit in order to stabilize LED operation and to prevent the device from igniting due to excess current.
5. Please avoid the stick of foreign material because molding resin in the products have adhesiveness. And please don't touch lens portion.
6. Please avoid overload to the product when using tweezers to pick up LEDs.
Overload might cause deformation, disconnection, crack and consequently lead to lighting failure.
Tweezer with wide-point is recommended, please avoid using sharp-point tweezer.
7. Please note external stress such as dropping and hitting may cause non-lighting due to deformation, crack and breaking. Ceramic tweezer with wide-point is recommended, please avoid using sharp-point one.
8. It is not recommended supersonic wave welding etc. after mounting the product.
There is a possibility of affecting on the junction part in package (junction part of die bonding and wire bonding). Please make sure there is no problem before using.
9. Please be careful when LED is soldered on a metal plate, since solder crack might be caused by heat.
10. Please note piling PCBs may stress LEDs. It may cause non-lighting due to deformation, crack and breaking.
11. This type of product is not water proof and moisture proof nor with salt corrosion protection, therefore attention should be paid when products are used under such conditions.
12. Please keep in desiccator regardless of before or after mounting not to be affected by corrosive gas when keeping products.
Also please make sure if there is any gas which occur in surrounding area or enter from outside when using products.
13. Please check the actual performance in the assembly because the Specification Sheets are described for LED device only.
14. Please refrain from looking directly at the light source of LED at high output, as it may harm your vision.
15. The products are designed to operate without failure in recommended usage conditions.
However, please take the necessary precautions to prevent fire, injury, and other damages should any malfunction or failure arise.
16. The products are manufactured to be used for ordinary electronic equipment. Please contact our sales staff beforehand when exceptional quality and reliability are required, and the failure or malfunction of the products might directly jeopardize life or health (such as for airplanes, aerospace, transport equipment, medical applications, nuclear reactor control systems and so on).
17. The formal specification sheets shall be valid only by exchange of documents signed by both parties.

【 Handling Precautions for Product Mounting 】

<Recommendation>

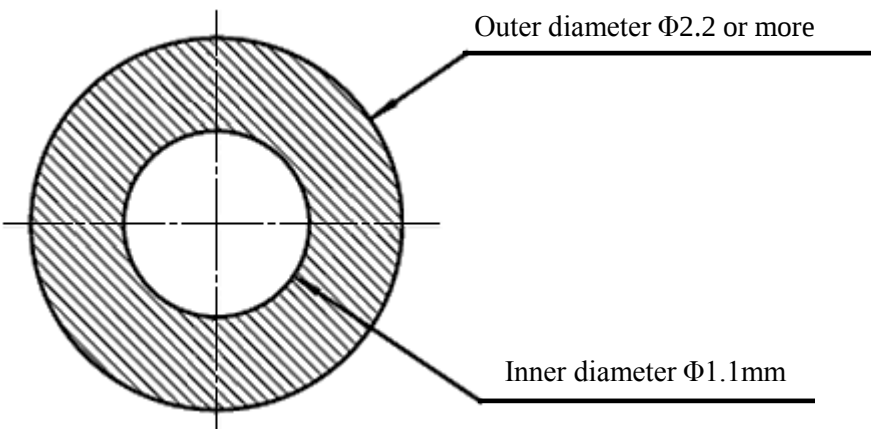
- Picking up point with nozzle : Lamp housing of the product ( area)
(Shown below)

The pick up point is lamp housing only because the silicone resin used for the lens is soft. (If the nozzle makes contact with the lens, the products might be destroyed)



Please adjust the load, the pick up point, the nozzle diameter and etc. before mounting because the over load can cause the breakage of the lamp housing.

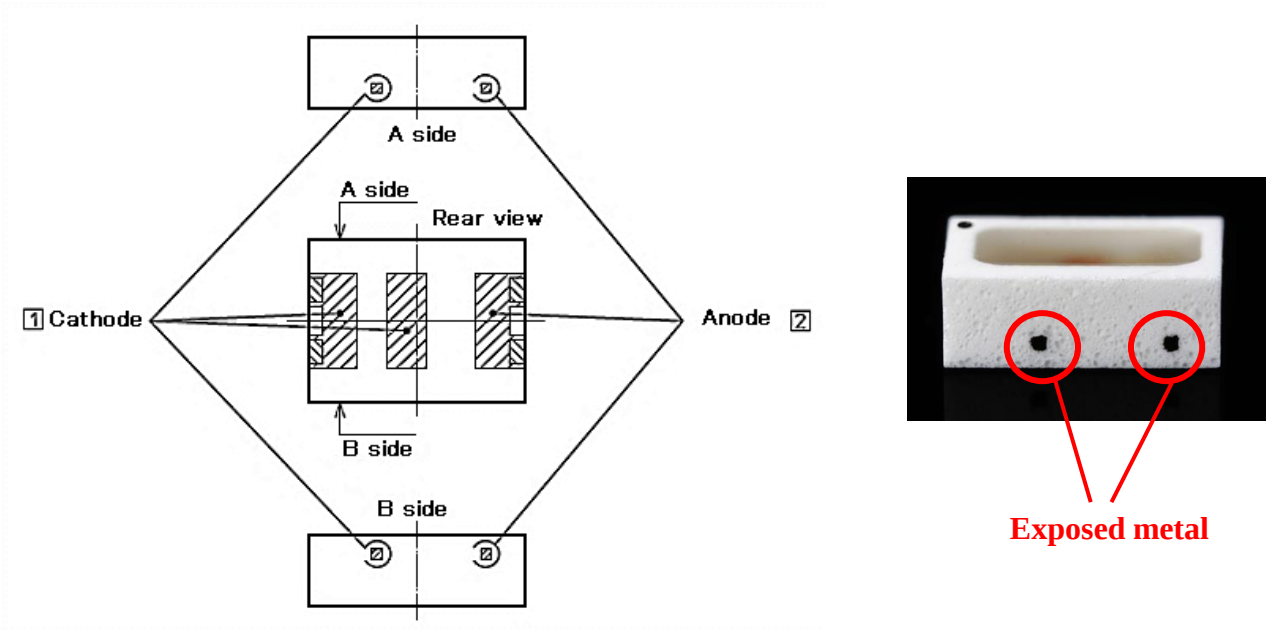
- Recommended nozzle shape



【 Other Precautions 】

1. Regarding exposed metal

This LED has exposed metal on the non soldering area. Please avoid touching electro conductive material on this exposed metal as it may connect with other electrode and short out.



Packaging Specifications

VFSR1112GS-3CX2A-TR

This product is baked (moisture removal) before packaging, and is shipped in moisture-proof packaging (as shown below) to minimize moisture absorption during transportation and storage. However, with regard to storing the products, Stanley recommends the use of dry-box under the following conditions is recommended. Moisture-proof bag as the packaging is made of anti-static material but packaging box is not.

【Recommended Storage Condition / Products Warranty Period 】

Temperature	+5~30℃
Humidity	Under 70%

In the case of the package unopened , 6 months under 【 Recommended Storage Condition 】.
Please avoid rapid transition from low temp. condition to high temp. condition
and storage in corroding and dusty environment.

【Time elapsed after Package Opening.】

The package should not be opened until immediately prior to its use, and please keep the time frame between package opening and soldering which is **【maximum 672h】**.
If the device needs to be soldered twice, both soldering operations must be completed within the 72h.

If any components should remain unused, please reseal the package and store them under the conditions described in the 【 Recommended Storage Condition 】 above.

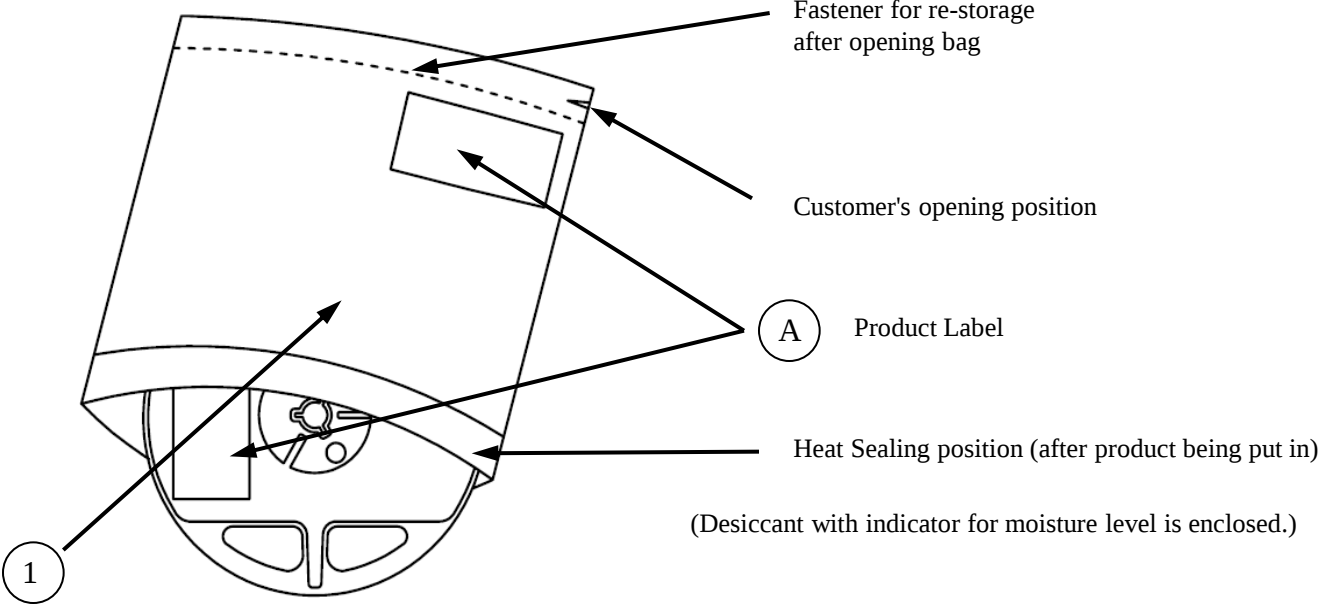
This product must be required to perform baking process (moisture removal) for **at 48h(MIN.) – 72h(MAX.) at 60±5 degrees Celsius** if following conditions apply.

1. In the case of silica gel (blue) which indicates the moisture level within the package, changes or loses its blue color.
2. In the case of time passes for 672h after the package is opened once.

Baking process should be performed after LED having been taken out of the package.

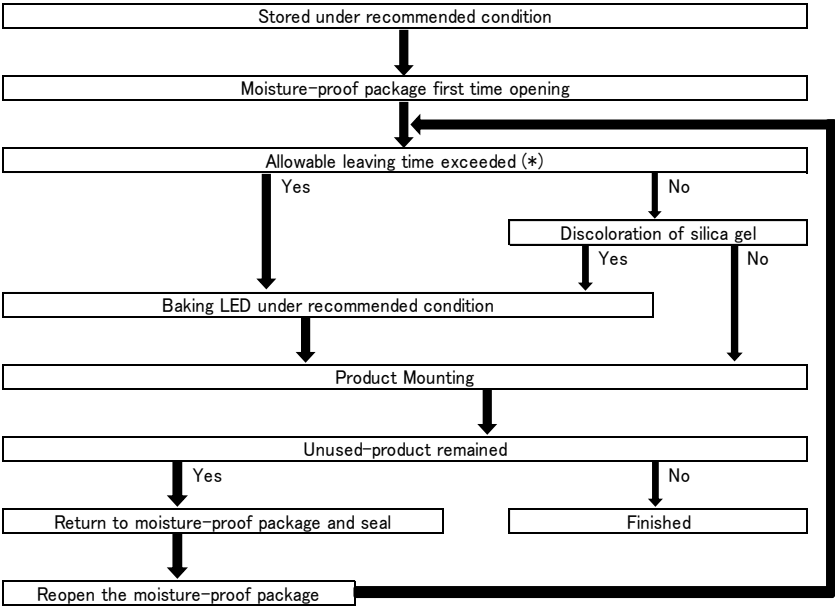
Baking may be performed in the tape-reel form , however if it is performed with the reel stacked over one another, it may cause deformation of the reels and taping materials and later obstruct mounting. Please handle only once it has returned to room temperature. Provided that, baking process shall be 2 times MAX.

【Moisture-proof Packaging Specification】



No.	PART NAME	MATERIAL	REMARKS
①	Moisture-proof bag with Aluminum layer	PET+Al+PE	with ESD protection

【Flow Chart-package Opening to Mounting】



Allowable leaving time means the maximum allowable leaving time after opening package, which depends on each LED type.

The allowable leaving time should be calculated from the first opening of package to the time when soldering process is finished.

When judging if the allowable leaving time has exceeded or not, please subtract the soldering time. The allowable leaving time after reopening should be calculated from the first opening of package, or from the time when baking process is finished.

Packaging Specifications

VFSR1112GS-3CX2A-TR

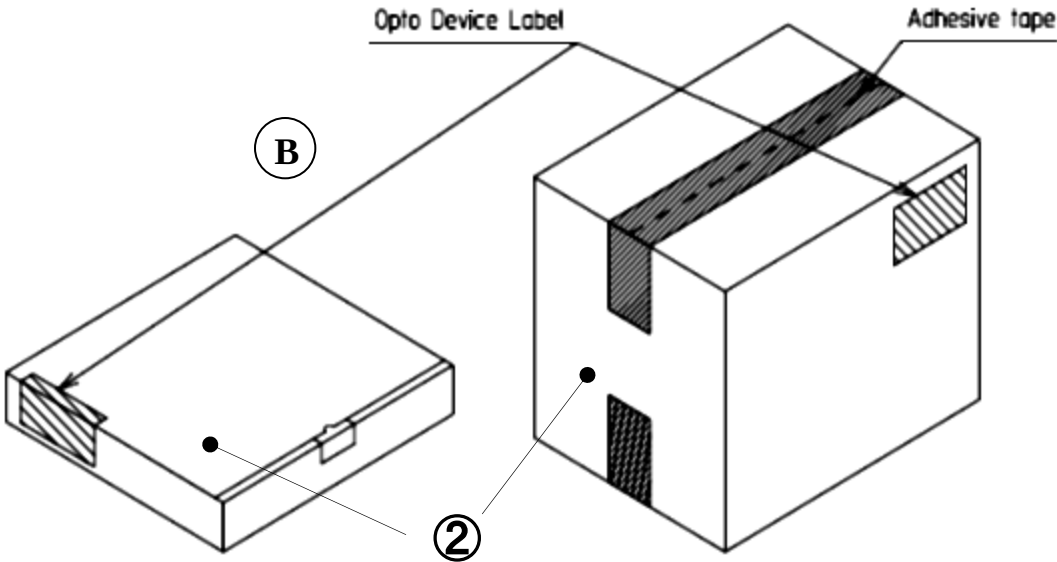
【Packing box】

(RoHS・ELV Compliant)

Box TYPE	Outline dimension L × W × H (mm)	Capacity of the box
Type A	280 × 265 × 45	3 reels
Type B	310 × 235 × 265	15 reels
Type C	440 × 310 × 265	30 reels

The above measure is all the reference value.

Shipping box is selected out of the above table by shipping quantity.



Type A

Material / box : Cardboard C5BF

Type B,C

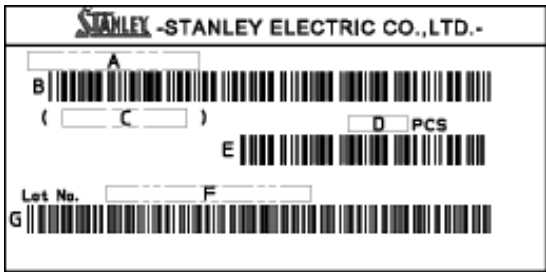
Material / box : Cardboard K5AF

Partition : Cardboard K5BF

No.	PART NAME	MATERIAL	REMARKS
②	Packing Box	Corrugated Cardboard	without ESD protection

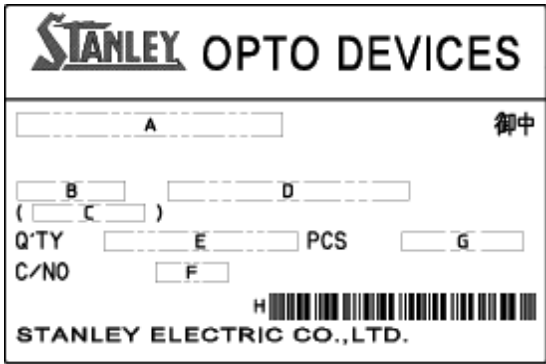
【Label Specification】
 (acc.to JIS-X0503(Code-39))

A
 Product Label



- A. Parts number
- B. Bar-code for parts number
- C. Parts code (In-house identification code for each parts number)
- D. Packed parts quantity
- E. Bar-Code for packed parts quantity
- F. Lot number & Rank
(refer to Lot Number Notational System for details)
- G. Bar-Code for Lot number & Rank

B
 Opto Device Label



- A. Customer Name
- B. Parts Type
- C. Parts Code
- D. Parts Number
- E. Packed Parts Quantity
- F. Carton Number
- G. Shipping Date
- H. Bar-Code for In-house identification Number

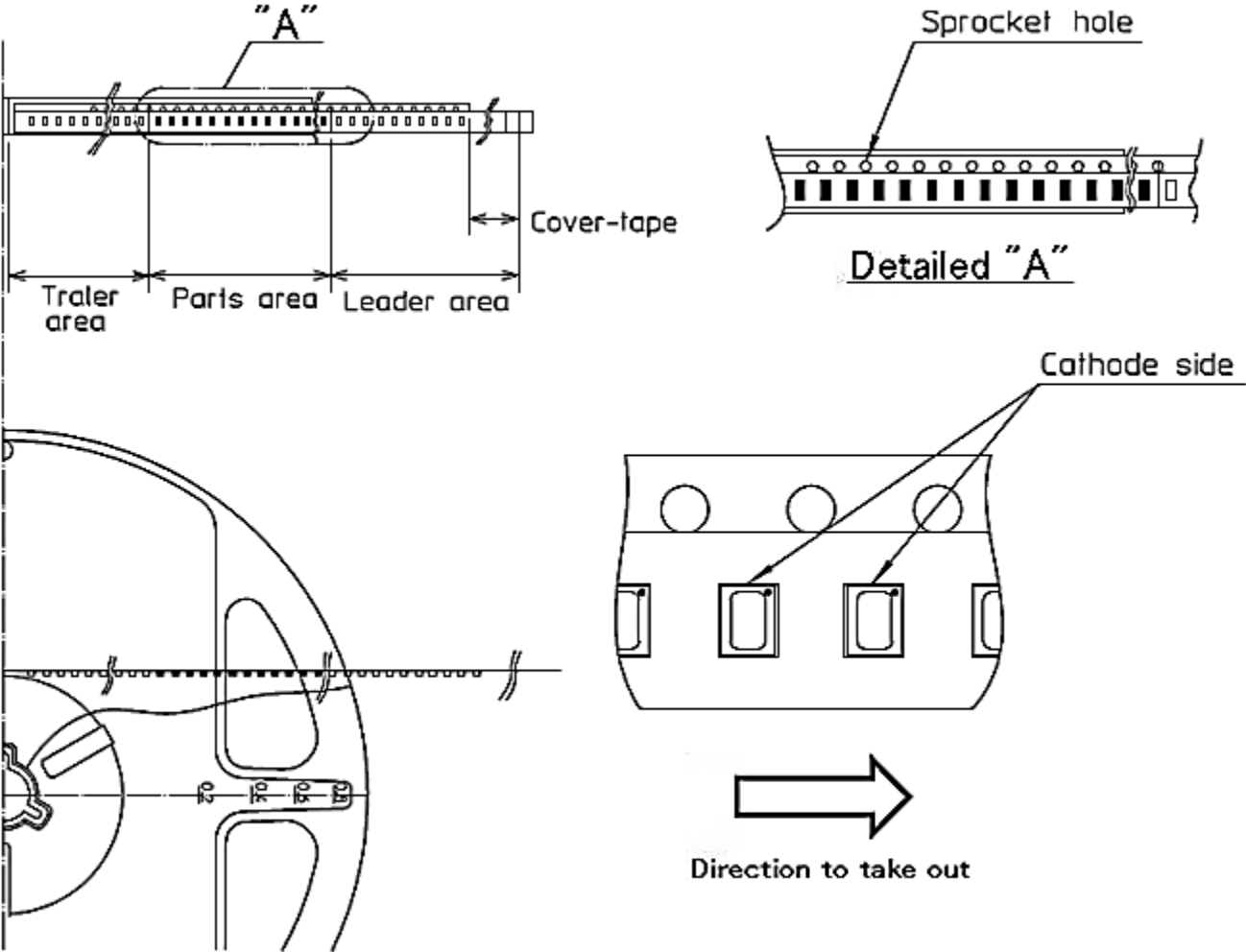
<Remark> Bar-code font : acc.to Code-39(JIX0503)

Taping and Reel Specifications

VFSR1112GS-3CX2A-TR

(acc.to JIS-C0806-03)

【Appearance】



Note
"-TR" means Cathode Side of LEDs should be placed on the sprocket-hole side.

Items		Specifications	Remarks
Leader area	Cover-tape	Cover-tape shall be longer than 300mm without carrier-tape	The end of cover-tape shall be held with adhesive tape.
	Carrier-tape	Empty pocket shall be more than 25 pieces.	Please refer to the above figure for Taping & reel orientation .
Trailer area		Empty pocket shall be more than 40 pieces.	The end of taping shall be inserted into a slit of the hub.

Taping and Reel Specifications

VFSR1112GS-3CX2A-TR

(acc.to JIS-C0806-03)

【Qty. per Reel】

3,000parts/reel

Minimum Qty. per reel might be 500 parts when getting less than 3,000 parts. In such case, parts of 500-unit-qty. shall be packed in a reel and the qty. shall be identified on the label.

【Mechanical strength】

Cover-tape adhesive strength shall be 0.1～1.0N (An angle between carrier-tape and cover-tape shall be170 deg.). Both tapes shall be so sealed that the contained parts will not come out from the tape when it is bent at a radius of 15mm.

【Others】

Reversed-orientation, Up-side down placing, side placing and out of spec. parts mix shall not be held. Max qty. of empty pocket per reel shall be defined as follows.

Max, qty. of empty pocket per reel shall be defined as follows.

Qty./Reel	Max.Qty. of empty pocket	Remarks
500	1	-
1,000	1	-
1,500	1	-
2,000	2	No continuance
2,500	2	No continuance
3,000	3	No continuance

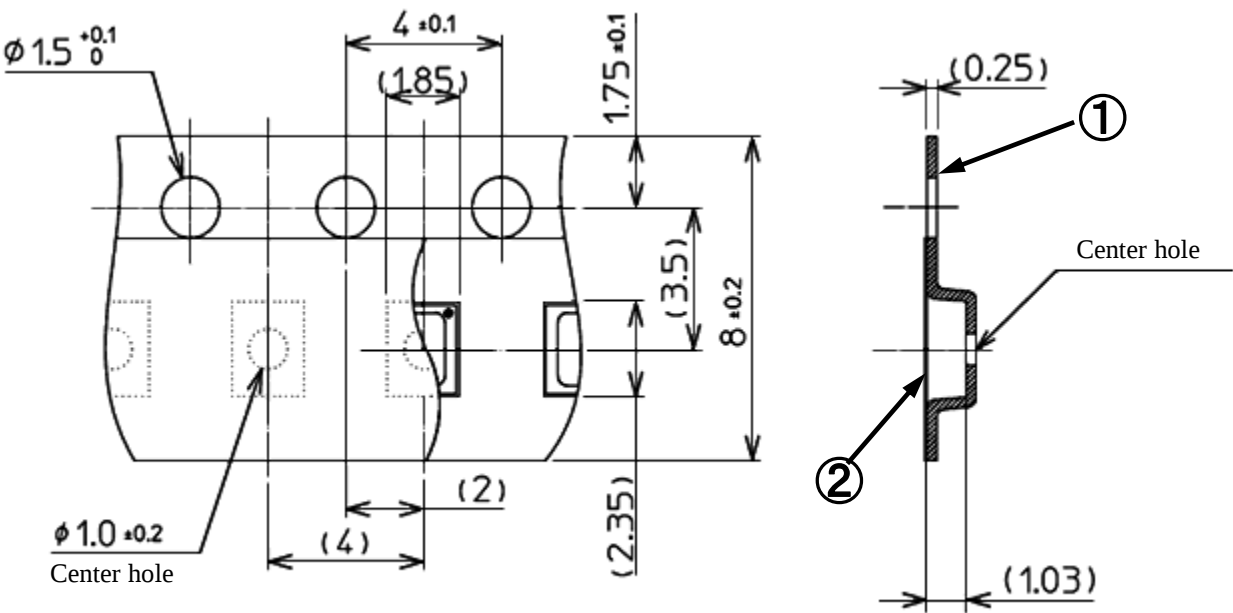
Taping and Reel Specifications

VFSR1112GS-3CX2A-TR

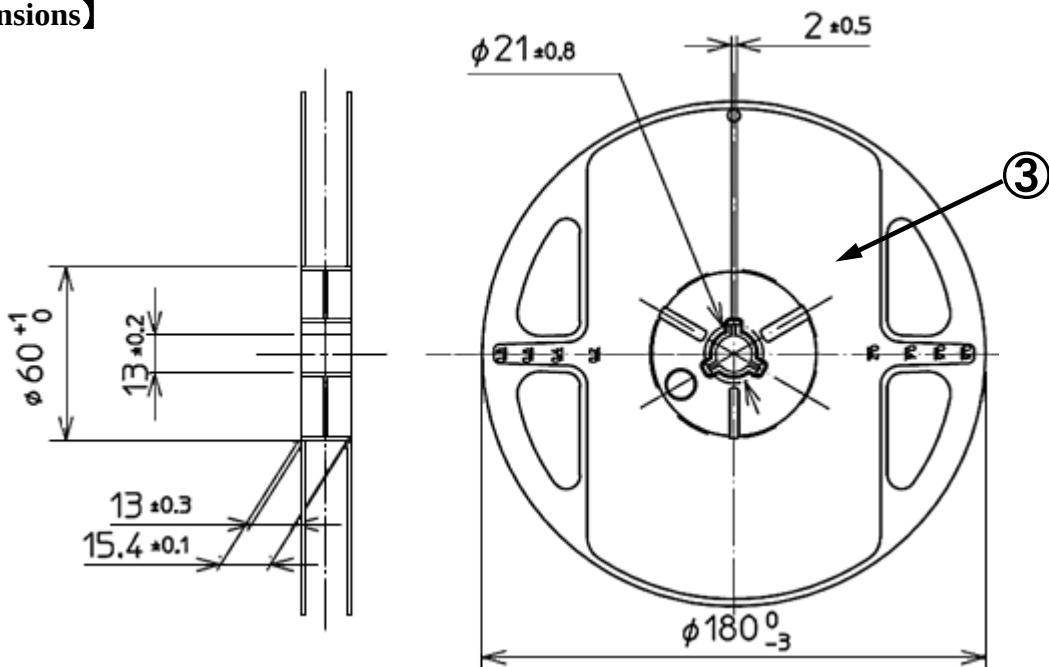
Unit : mm

(acc.to JIS-C0806-03)

【Taping Dimensions】



【Reel Dimensions】



NO.	PART NAME	REMARKS
①	Carrier-tape	Anti-Static Grade
②	Cover-tape	Anti-Static Grade
③	Carrier-reel	Anti-Static Grade

Lot Number Notational System

VFSR1112GS-3CX2A-TR

①	②	③	④	⑤	⑥	⑦	⑧	⑨							

① - 1digit : Production Location (Mark identify alphabet)

② - 1digit : Production Year (Last digit of Production Year 2015→5,2016→6,2017→7,···)

③ - 2digits : Production Month (Jan. to Sep. , should be 01,02,03,·····)

④ - 2digits : Production Date

⑤ - 3digits : Serial Number

⑥ - 2digits : Tape and Reel following Number

⑦ - 2digits : Luminous Intensity Rank.

(If luminous intensity rank is 1 digit, "-" shall be dashed on the place for the second digit.

If there is no identified intensity rank, "- -" is used to indicate.)

⑧ - 2digits : Chromaticity Rank

(If chromaticity rank is 1 digit, "-" shall be dashed on the place for the second digit.

If there is no identified intensity rank, "- -" is used to indicate.)

⑨ - 1digit : Option Rank (Stanley normally print "-" to indicate)

Correspondence to RoHS・ELV instruction VFSR1112GS-3CX2A-TR

This product is in compliance with RoHS・ELV.

Prohibition substance and it's criteria value of RoHS・ELV are as follows.

- RoHS instruction Refer to following (1)～(6).
- ELV instruction Refer to following (1)～(4).

	Substance Group Name	Criteria Value
(1)	Lead and its compounds	1,000ppm Max
(2)	Cadmium and its compounds	100ppm Max
(3)	Mercury and its compounds	1,000ppm Max
(4)	Hexavalent chromium	1,000ppm Max
(5)	PBB	1,000ppm Max
(6)	PBDE	1,000ppm Max

Reliability Testing Result

VFSR1112GS-3CX2A-TR

1. Reliability Testing Result

Test Item	Standard	Test Condition	Duration	Failure
Room Temperature Operating Life	EIAJ ED-4701 /100(101)	Ta=25°C I _F =70mA	1,000h	0 / 20
High Temperature Operating Life	EIAJ ED-4701 /100(101)	Ta=85°C I _F =70mA	1,000h	0 / 20
Low Temperature Operating Life	EIAJ ED-4701 /100(101)	Ta=-40°C I _F =70mA	1,000h	0 / 20
Wet High Temperature Operating Life	EIAJ ED-4701 /100(102)	Ta=60°C Rh=90% I _F =70mA	1,000h	0 / 20
High Temperature Storage Life	EIAJ ED-4701 /200(201)	Ta=110°C	1,000h	0 / 20
Low Temperature Storage Life	EIAJ ED-4701 /200(202)	Ta=-40°C	1,000h	0 / 20
Wet High Temperature Storage Life	EIAJ ED-4701 /100(101)	Ta=60°C Rh=90%	1,000h	0 / 20
Thermal Shock	EIAJ ED-4701 /100(105)	Ta=-40°C ~ 110°C (each 15min)	1,000 cycles	0 / 20
Thermal Shock Operating	EIAJ ED-4701 /100(105)	Ta=-40°C(OFF) ~ 85°C(I _F =20mA ON) (each 15min)	1,000 cycles	0 / 20
Cycled Temperature Humidity Operating Life	EIAJ ED-4701 /200(203)	Ta=-30°C ~ 80°C 95% 8h/cycle I _F =10mA 5min on-off	30 cycles	0 / 20
Resistance to Reflow Soldering	EIAJ ED-4701 /300(301)	Moisture Soak : 30°C 70% 672h Preheating : 150~180°C 90-120sec Soldering : 260°C peak	2times	0 / 20
Electrostatic Discharge(ESD) ※	EIAJ ED-4701 /300(304)	C=100pF R2=1.5kΩ ±2,000V	once each polarity	0 / 20
Vibration, Variable Frequency	EIAJ ED-4701 /400(403)	98.1m/s ² (10G) 100~2,000Hz 20min sweep XYZ direction	Each direction	0 / 20

※ Reference test

2. Failure Criteria

Item	Symbol	Condition	Failure Criteria
Luminous Intensity	I _V	I _F =20mA	Testing Min. Value < Standard Min. Value × 0.5
Forward Voltage	V _F	I _F =20mA	Testing Max. Value ≥ Standard Max. Value × 1.2
Reverse Current	I _R	V _R =5V	Testing Max. Value ≥ Standard Max. Value × 2.5
External Appearance	-	-	Notable discoloration, deformation and cracking

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